MOSFETs Silicon N-channel MOS (U-MOSVII-H)

TPN5900CNH

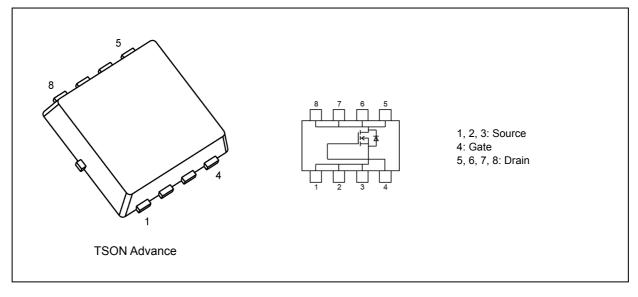
1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators

2. Features

- (1) High-speed switching
- (2) Small gate charge: $Q_{SW} = 2.6 \text{ nC}$ (typ.)
- (3) Low drain-source on-resistance: $R_{DS(ON)} = 50 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (4) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 150 \ V)$
- (5) Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 0.2 mA)

3. Packaging and Internal Circuit



roshiba

4. Absolute Maximum Ratings (Note) ($T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characteris	tics		Symbol	Rating	Unit
Drain-source voltage			V _{DSS}	150	V
Gate-source voltage			V _{GSS}	±20	1
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	Ι _D	18	A
Drain current (DC)	(Continuous)	(Note 1)	Ι _D	9.0]
Drain current (pulsed)	(t = 1 ms)	(Note 1)	I _{DP}	35	
Power dissipation	(T _c = 25 °C)		PD	39	W
Power dissipation	(t = 10 s)	(Note 3)	PD	1.9]
Power dissipation	(t = 10 s)	(Note 4)	PD	0.7	
Single-pulse avalanche energy	·	(Note 5)	E _{AS}	37	mJ
Avalanche current			I _{AR}	9.0	A
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25 °C)		R _{th(ch-c)}	3.20	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	65.7	
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 4)	R _{th(ch-a)}	178	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

FR-4

(Unit: mm)

Note 2: Limited by silicon chip capability.

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5: V_{DD} = 60 V, T_{ch} = 25 °C (initial), L = 640 μ H, I_{AR} = 9.0 A

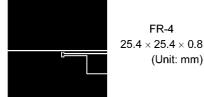
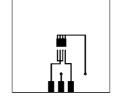


Fig. 5.1 Device Mounted on a Glass-Epoxy

Board (a)



FR-4 $25.4\times25.4\times0.8$ (Unit: mm)

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_	_	±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V	_	_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	150	_	—	V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	105	_	_]
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 0.2 mA	2.0	_	4.0]
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 4.5 A	_	50	59	mΩ

6.2. Dynamic Characteristics (T_a = 25 $^{\circ}$ C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz	_	460	600	pF
Reverse transfer capacitance	C _{rss}		_	3.0	50	
Output capacitance	C _{oss}		_	80	_	
Gate resistance	rg	—	_	4.0	6.0	Ω
Switching time (rise time)	t _r	See Fig. 6.2.1	_	5.2	_	ns
Switching time (turn-on time)	t _{on}		_	14	_	
Switching time (fall time)	t _f		_	4.5	_	
Switching time (turn-off time)	t _{off}		—	19	_	

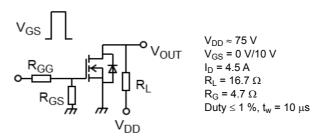


Fig. 6.2.1	Switching	Time	Test	Circuit
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6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

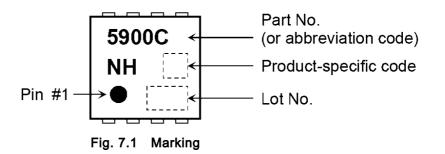
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD}\approx75$ V, V_{GS} = 10 V, I_{D} = 9.0 A	—	7.0	—	nC
Gate-source charge 1	Q _{gs1}		_	2.4	_	nC
Gate-drain charge	Q _{gd}		_	1.5	_	
Gate switch charge	Q _{SW}			2.6		

6.4. Source-Drain Characteristics ($T_a = 25$ °C unless otherwise specified)

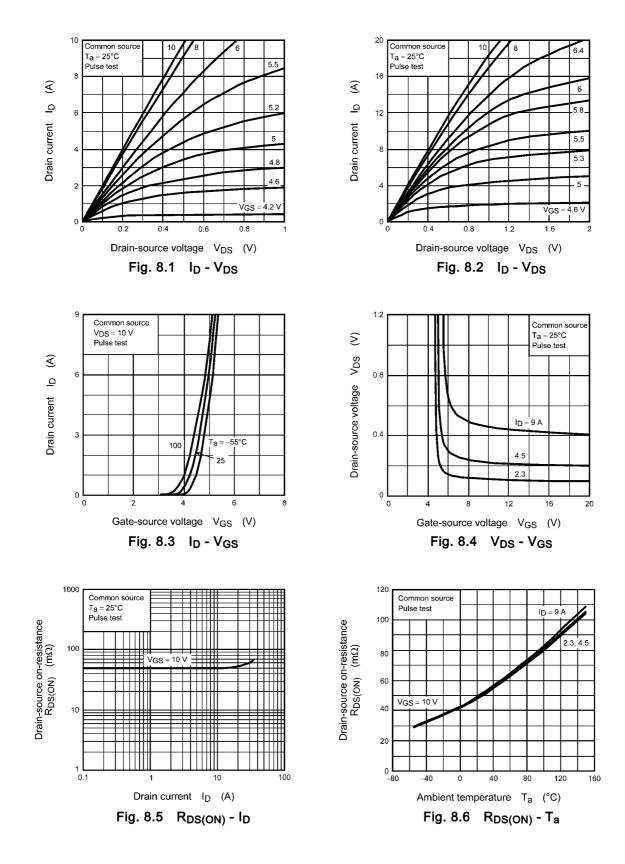
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 6) I _{DRP}	—	_	_	35	А
Diode forward voltage	V _{DSF}	I _{DR} = 9.0 A, V _{GS} = 0 V			-1.2	V

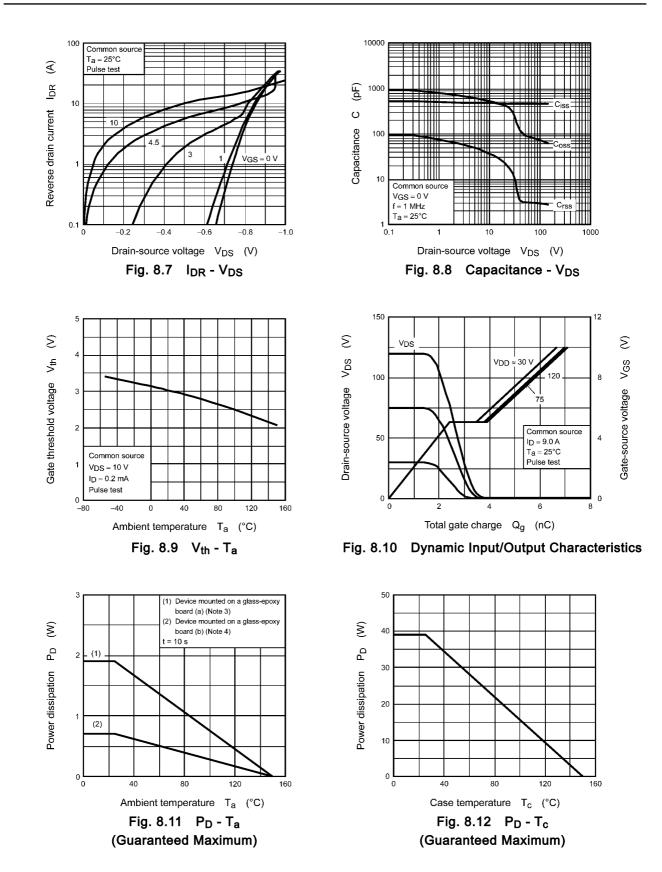
Note 6: Ensure that the channel temperature does not exceed 150 $^\circ \text{C}.$

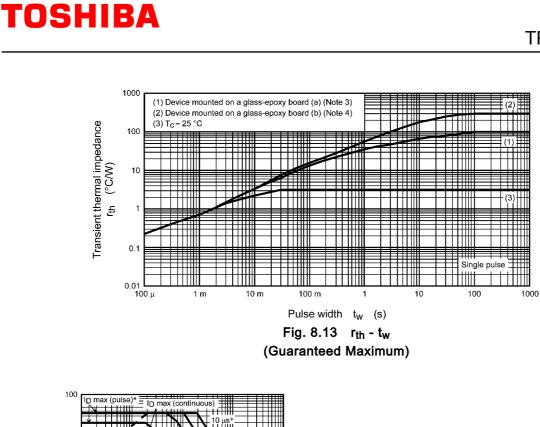
7. Marking

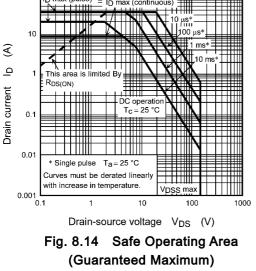


8. Characteristics Curves (Note)





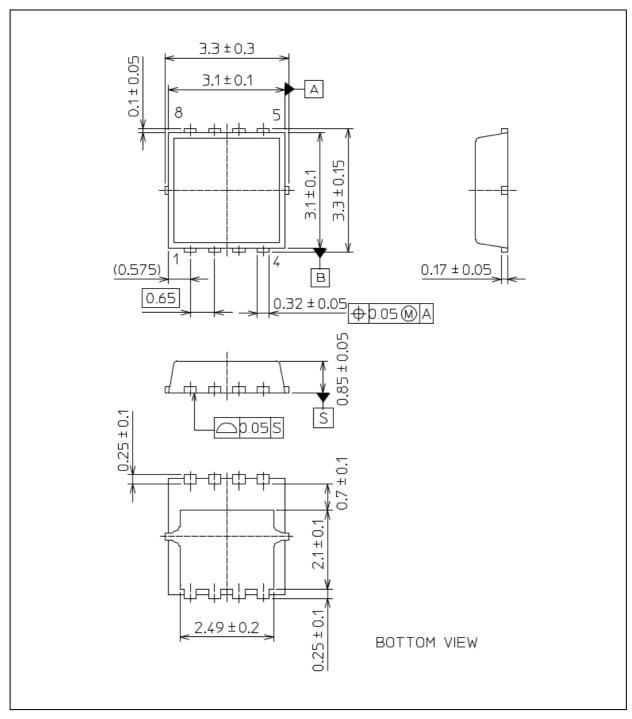




Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)			
TOSHIBA: 2-3X1S			
Nickname: TSON Advance			

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